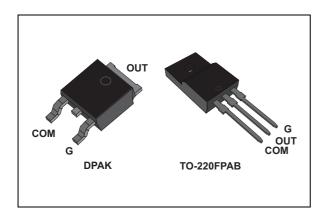


Overvoltage protected AC switch

Datasheet - production data



Features

- Triac with overvoltage protection
- Low I_{GT} (<10 mA) or high immunity (I_{GT} < 35 mA) version
- High noise immunity: static dV/dt > 1000 V/μs
- TO-220FPAB insulated package:
 - complies with UL standards (File ref : E81734)
 - insulation voltage: 2000 V_{RMS}

Benefits

- Enables equipment to meet IEC 61000-4-5
- · High off-state reliability with planar technology
- · Needs no external overvoltage protection
- Reduces the power passive component count
- High immunity against fast transients described in IEC 61000-4-4 standards

Applications

- AC mains static switching in appliance and industrial control systems
- · Drive of medium power AC loads such as:
 - Universal motor of washing machine drum
 - Compressor for fridge or air conditioner

Description

The ACST4 series belongs to the ACS / ACST power switch family. This high performance device is suited to home appliances or industrial systems and drives loads up to 4 A.

This ACST4 switch embeds a Triac structure with a high voltage clamping device to absorb the inductive turn-off energy and withstand line transients such as those described in the IEC 61000-4-5 standards. The ACST410 needs a low gate current to be activated (I_{GT} < 10 mA) and still shows a high electrical noise immunity complying with IEC standards such as IEC 61000-4-4 (fast transient burst test).

Figure 1. Functional diagram

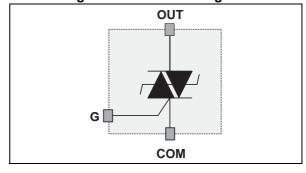


Table 1. Device summary

Symbol	Value	Unit
I _{T(RMS)}	4	Α
V_{DRM}/V_{RRM}	800	V
I _{GT} (ACST410)	10	mA
I _{GT} (ACST435)	35	mA

Characteristics ACST4

1 Characteristics

Table 2. Absolute maximum ratings (limiting values)

Symbol	Paramete		Value	Unit	
		TO-220FPAB	T _c = 102 °C	4	А
I _{T(RMS)}	On-state rms current (full sine wave)	DPAK	T _c = 112 °C	4	
T (RIVIS)		DPAK with 0.5 cm² copper	T _{amb} = 60 °C	1	
1.	Non repetitive surge peak on-state current	F = 60 Hz	t _p = 16.7 ms	32	Α
I _{TSM}	(full cycle sine wave, T _J initial = 25 °C)	F = 50 Hz	t _p = 20 ms	30	Α
l ² t	I ² t Value for fusing	t _p = 10 ms	6	A ² s	
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r = 100 \text{ ns}$		T _j = 125 °C	100	A/µs
V _{PP} ⁽¹⁾	Non repetitive line peak mains voltage (1)	T _j = 25 °C	2	kV	
P _{G(AV)}	Average gate power dissipation	T _j = 125 °C	0.1	W	
P _{GM}	Peak gate power dissipation (t _p = 20 μs)	T _j = 125 °C	10	W	
I _{GM}	Peak gate current (t _p = 20 μs)	1.6	Α		
T _{stg} T _j	Storage junction temperature range Operating junction temperature range	-40 to +150 -40 to +125	°C		
T _I	Maximum lead soldering temperature durin	from plastic case)	260	°C	
V _{INS(RMS)}	Insulation RMS voltage (60 seconds)		T0-220FPAB	2000	V

^{1.} According to test described in IEC 61000-4-5 standard and Figure 18

Table 3. Electrical characteristics ($T_j = 25$ °C, unless otherwise specified)

Symbol	Test conditions Quadra			ACST410	ACST435	Unit
I _{GT} ⁽¹⁾	V_{OUT} = 12 V, R_L = 33 Ω	I - II - III	MAX	10	35	mA
V _{GT}	$V_{OUT} = 12 \text{ V}, R_L = 33 \Omega$	1 - 11 - 111	MAX	1.0	1.1	V
V_{GD}	$V_{OUT} = V_{DRM}$, $R_L = 3.3 \text{ k}\Omega$, $T_j = 125 ^{\circ}\text{C}$ I - II - III			0.2		V
I _H ⁽²⁾	I _{OUT} = 500 mA			20	25	mA
ΙL	I _G = 1.2 x I _{GT}	I - II-III	MAX	40	60	mA
dV/dt (2)	V _{OUT} = 67% V _{DRM} gate open, T _j = 125 °C			500	1000	V/µs
(dl/dt)c (2)	without snubber, T _j = 125 °C				5	A/ms
(dl/dt)c (2)	$(dV/dt)c = 15 V/\mu s, T_j = 125 °C$			2		A/ms
V _{CL}	$I_{CL} = 0.1 \text{ mA}, t_p = 1 \text{ ms}$		MIN	85	50	V

^{1.} Minimum $I_{\mbox{\scriptsize GT}}$ is guaranteed at 5% of $I_{\mbox{\scriptsize GT}}$ max



^{2.} For both polarities of OUT pin referenced to COM pin

ACST4 Characteristics

Table 4. Static electrical characteristics

Symbol	Test conditions	Value	Unit		
V _{TM} ⁽¹⁾	$I_{TM} = 5.6 \text{ A}, t_p = 500 \mu \text{s}$	T _j = 25 °C	MAX	1.7	V
V _{TO} ⁽¹⁾	Threshold voltage	T _j = 125 °C	MAX	0.9	V
R _D ⁽¹⁾	Dynamic resistance	T _j = 125 °C	MAX	110	m Ω
I _{DRM}	V	T _j = 25 °C	MAX	20	μΑ
I _{RRM}	$V_{OUT} = V_{DRM} / V_{RRM}$	T _j = 125 °C	IVIAA	0.5	mA

^{1.} For both polarities of OUT pin referenced to COM pin

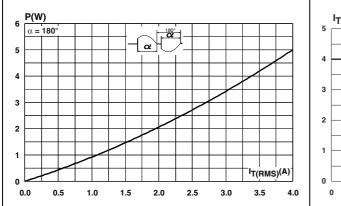
Table 5. Thermal resistances

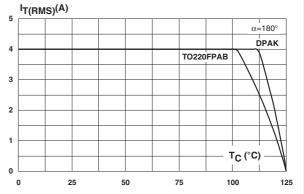
Symbol	Para		Value	Unit	
R _{th/(i-c)} Junction to case for full cycle sine wave condu		we conduction	DPAK	2.6	
R _{th(j-c)}	Junction to case for full cycle sine wa	TO-220FPAB	4.6	°C/W	
R _{th/(-a)} Junction to ambient			TO-220FPAB	60	C/VV
R _{th(j-a)}	Junction to ambient	$S_{CU}^{(1)} = 0.5 \text{ cm}^2$	DPAK	70	

^{1.} S_{CU} = copper surface under tab

Figure 2. Maximum power dissipation versus on-state RMS current

Figure 3. On-state RMS current versus case temperature (full cycle)





Characteristics ACST4

Figure 4. On-state RMS current versus ambient temperature (free air convection, full cycle)

Figure 5. Relative variation of thermal impedance versus pulse duration

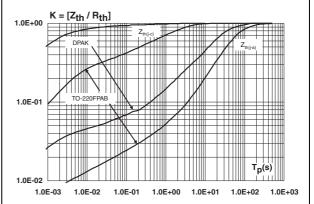


Figure 6. Relative variation of gate trigger current (I_{GT}) and voltage (V_{GT}) versus junction temperature (typical values)

T_a(°C)

75

100

50

0.5

0.0

0

 I_{GT} , V_{GT} $[T_j]$ / I_{GT} , V_{GT} $[T_j = 25 ^{\circ}C]$ 3.0 2.5 GT_Q1-Q2 2.0 1.5 -V_{GT} Q 1-Q2-Q 3 1.0 0.5 T_i(°C) 0.0 -25 0 25 50 75 125 -50 100

Figure 7. Relative variation of holding current (I_H) and latching current (I_L) versus junction temperature (typical values)

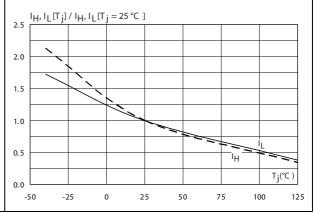
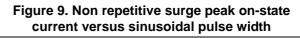
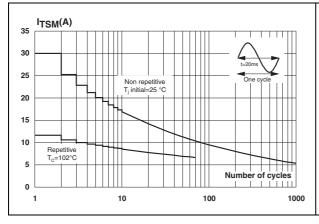
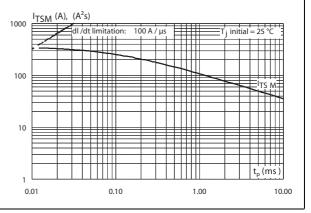


Figure 8. Surge peak on-state current versus number of cycles





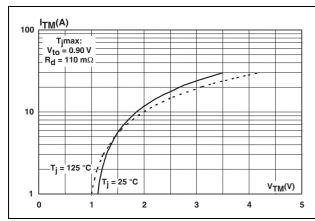


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ACST4 Characteristics

Figure 10. On-state characteristics (maximum values)

Figure 11. Relative variation of critical rate of decrease of main current (dl/dt)_c versus junction temperature



(dl/dt)_C [T_j] / (dl/dt)_C [T_j = 125 °C]

8

7

6

5

4

3

2

1

0

25

50

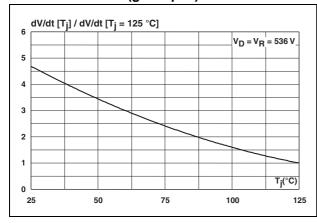
75

100

125

Figure 12. Relative variation of static dV/dt immunity versus junction temperature (gate open)

Figure 13. Relative variation of leakage current versus junction temperature



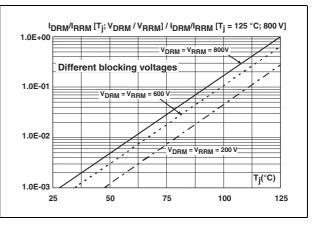
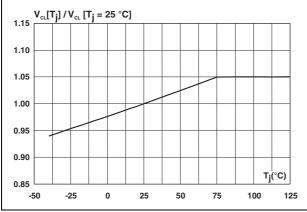
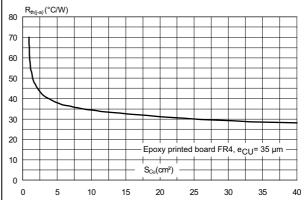


Figure 14. Relative variation of the clamping voltage (V_{CL}) versus junction temperature (minimum values)

Figure 15. Thermal resistance junction to ambient versus copper surface under tab





2 Application information

2.1 Typical application description

The ACST4 device has been designed to control medium power load, such as AC motors in home appliances. Thanks to its thermal and turn off commutation performances, the ACST4 switch is able to drive an inductive load up to 4 A with no turn off additional snubber. It also provides high thermal performances in static and transient modes such as the compressor inrush current or high torque operating conditions of an AC motor. Thanks to its low gate triggering current level, the ACST4 can be driven directly by an MCU through a simple gate resistor as shown *Figure 16* and *Figure 17*.

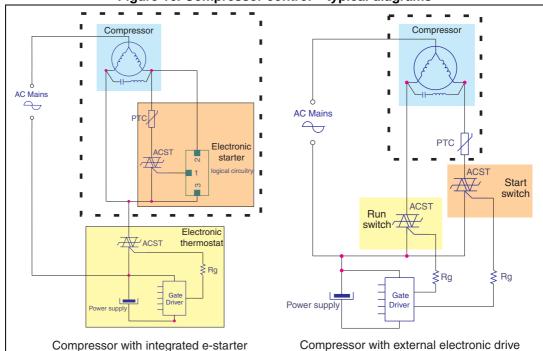


Figure 16. Compressor control – typical diagrams

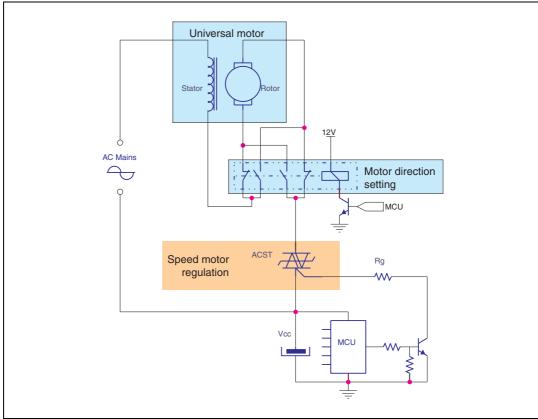


Figure 17. Universal drum motor control – typical diagram

2.2 AC line transient voltage ruggedness

In comparison with standard Triacs, which are not robust against surge voltage, the ACST4 is self-protected against over-voltage, specified by the new parameter V_{CL} . The ACST4 switch can safely withstand AC line transient voltages either by clamping the low energy spikes, such as inductive spikes at switch off, or by switching to the on state (for less than 10 ms) to dissipate higher energy shocks through the load. This safety feature works even with high turn-on current ramp up.

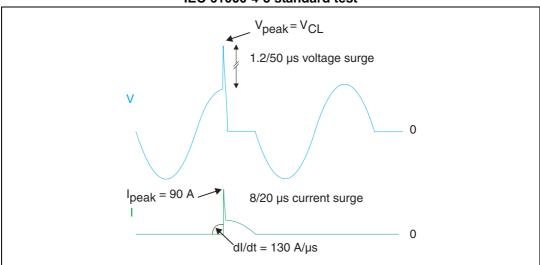
The test circuit of *Figure 18* represents the ACST4 application, and is used to stress the ACST switch according to the IEC 61000-4-5 standard conditions. With the additional effect of the load which is limiting the current, the ACST switch withstands the voltage spikes up to 2 kV on top of the peak line voltage. The protection is based on an overvoltage crowbar technology. The ACST4 folds back safely to the on state as shown in *Figure 19*. The ACST4 recovers its blocking voltage capability after the surge and the next zero current crossing. Such a non repetitive test can be done at least 10 times on each AC line voltage polarity.



 $R = 23 \ \Omega, \ L = 2 \ \mu H, \ V surge = 2 \ kV$ $Rg = 220 \ \Omega \ (ACST410-8), \ 68 \ \Omega \ (ACST435-8)$ Surge generator $2kV \ surge$ Rgene Rgene

Figure 18. Overvoltage ruggedness test circuit for resistive and inductive loads for IEC 61000-4-5 standards

Figure 19. Typical current and voltage waveforms across the ACST4 during IEC 61000-4-5 standard test



ACST4 Package information

3 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque (TO-220FPAB): 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

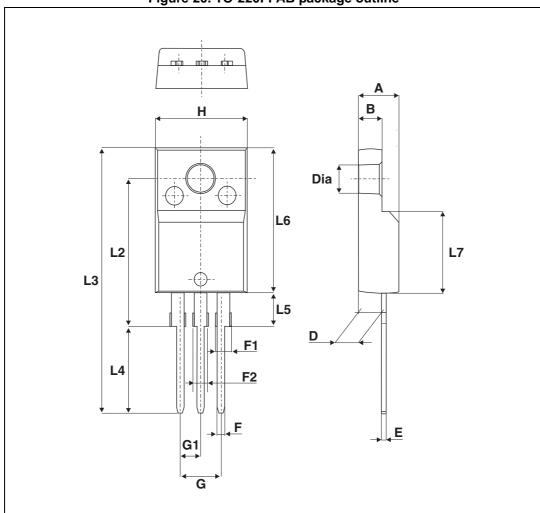


Figure 20. TO-220FPAB package outline

Package information ACST4

Table 6. TO-220FPAB package mechanical data

	Dimensions					
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	4.4		4.6	0.1732		0.1811
В	2.5		2.7	0.0984		0.1063
D	2.5		2.75	0.0984		0.1083
Е	0.45		0.70	0.0177		0.0276
F	0.75		1	0.0295		0.0394
F1	1.15		1.70	0.0453		0.0669
F2	1.15		1.70	0.0453		0.0669
G	4.95		5.20	0.1949		0.2047
G1	2.4		2.7	0.0945		0.1063
Н	10		10.4	0.3937		0.4094
L2		16			0.6299	
L3	28.6		30.6	1.1260		1.2047
L4	9.8		10.6	0.3858		0.4173
L5	2.9		3.6	0.1142		0.1417
L6	15.9		16.4	0.6260		0.6457
L7	9.00		9.30	0.3543		0.3661
Dia.	3.00		3.20	0.1181		0.1260

ACST4 Package information

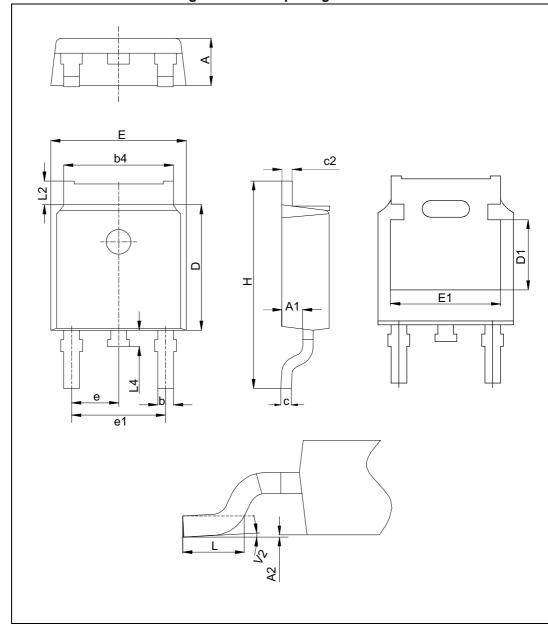


Figure 21. DPAK package outline

Note:

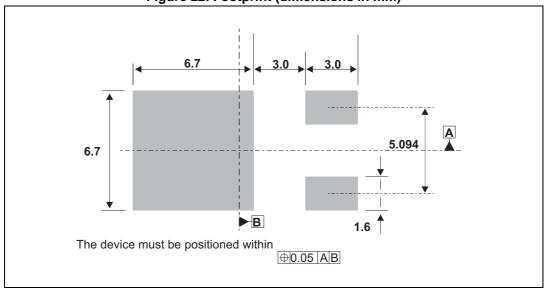
This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Package information ACST4

Table 7. DPAK package mechanical data

			Dime	nsions		
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.18		2.40	0.0858		0.0945
A1	0.90		1.10	0.0354		0.0433
A2	0.03		0.23	0.0012		0.0091
b	0.64		0.90	0.0252		0.0354
b4	4.95		5.46	0.1949		0.2150
С	0.46		0.61	0.0181		0.0240
c2	0.46		0.60	0.0181		0.0240
D	5.97		6.22	0.2350		0.2449
D1	4.95		5.60	0.1949		0.2205
E	6.35		6.73	0.2500		0.2650
E1	4.32		5.50	0.1701		0.2165
е		2.286			0.0900	
e1	4.40		4.70	0.1732		0.1850
Н	9.35		10.40	0.3681		0.4094
L	1.00		1.78	0.0394		0.0701
L2			1.27			0.0500
L4	0.60		1.02	0.0236		0.0402
V2	-8°		8°	-8°		8°

Figure 22. Footprint (dimensions in mm)



ACST4 Ordering information

4 Ordering information

Figure 23. Ordering information scheme

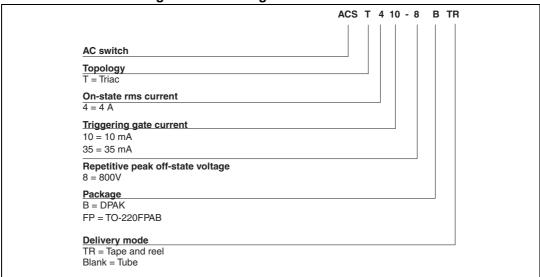


Table 8. Ordering information

Order code	Marking	Package	Weight	Base Qty	Delivery mode
ACST410-8B		DPAK	1.5 g	50	Tube
ACST410-8BTR	ACST4108	DPAK	1.5 g	1000	Tape and reel
ACST410-8FP		TO-220FPAB	2.4 g	50	Tube
ACST435-8B		DPAK	1.5 g	50	Tube
ACST435-8BTR	ACST4358	DPAK	1.5 g	1000	Tape and reel
ACST435-8FP		TO-220FPAB	2.4 g	50	Tube

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
Jan-2003	3A	Previous update.
04-Jul-2007	4	Reformatted to current standard. Added package.
18-Dec-2009	5	V _{DRM} /V _{RRM} updated to 800 V. Order codes updated.
02-Jun-2014	6	Updated DPAK package information and reformatted to current standard.
21-Oct-2014	7	Updated Table 2, Table 3, Table 4, Features and Description.
18-May-2017	8	Updated Features in cover page, Table 2 and Figure 14.

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